

Cree[®] XLamp[®] XB-D LEDs



CREE

PRODUCT DESCRIPTION

The XLamp XB-D LED brings nextgeneration performance, price and size to all LED lighting applications. The XB-D's footprint enables smaller designs with densely packed arrays for better light mixing and concentration.

XB-D shares common footprint and uniform package design across all white and color configurations, simplifying board and optical designs for many LED systems. XB-D is optimized to dramatically lower system cost in any illumination application, from indoor and outdoor lighting to architectural and transportation lighting.



FEATURES

- Cree's smallest lighting class LED: 2.45 X 2.45 mm
- XB-D white binned @ 85 °C;
 XB-D color binned @ 25 °C
- Up to 136 lm/W in cool white (@ 85 °C, 350 mA)
- Available in white, 80-minimum CRI white, and 70-minimum CRI cool white, royal blue, blue, green, amber, red-orange & red
- 1 A maximum drive current
- Wide viewing angle: from 115° (white) to 140° (red)
- Reflow solderable JEDEC J-STD-020C compatible
- Unlimited floor life at ≤ 30 °C/85% RH
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)





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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		6.5	
Thermal resistance, junction to solder point - green	°C/W		11	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - amber, red-orange, red	degrees		140	
Temperature coefficient of voltage - white	mV/°C		-2.5	
Temperature coefficient of voltage - royal blue, blue, green	mV/°C		-3.3	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-2	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1000
Reverse voltage	V			-5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.5
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.7
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.25	2.6
LED junction temperature	°C			150



FLUX CHARACTERISTICS - WHITE (T₁ = 85 °C)

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

Color	CCT Range			se Order Coo . Luminous @ 350 mA			d Minimum Flux (lm)**	Order Code	
	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1000 mA		
Cool White	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-000000F51	
Cool White	5000 K	8300 K	R2	114	130	196	253	XBDAWT-00-0000-000000E51	
70 CRI Minimum	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-00000BF51	
Cool White	3000 K	6300 K	R2	114	130	196	253	XBDAWT-00-0000-00000BE51	
			R2	114	130	196	253	XBDAWT-00-0000-00000LEE4	
Neutral White	3700 K	5000 K	Q5	107	122	184	237	XBDAWT-00-0000-00000LDE4	
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE4	
			Q4	100	114	172	222	XBDAWT-00-0000-00000HCE7	
80 CRI Minimum White	2600 K	6200 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000HBE7	
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000HAE7	
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE7	
Warm White	2600 K	00 К 3700 К	Q3	93.9	107	162	208	XBDAWT-00-0000-00000LBE7	
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000LAE7	

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements.
- Typical CRI for Neutral White, 3700 K 5000K CCT is 75.
- Typical CRI for Warm White, 2600 K 3700 K CCT is 80.
- Minimum CRI for 70 CRI Minimum Cool White is 70.
- Minimum CRI for 80 CRI Minimum White is 80.
- * Flux values @ 25 °C are calculated and are for reference only.
- ** Calculated flux values at 700 mA and 1000 mA are for 85 °C and are for reference only.



FLUX CHARACTERISTICS - COLOR (T₁ = 25 °C)

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

	Domi	Dominant Wavelength Range				rder Codes		
Color	Min.		Max.		Min. Radiant Flux (mW) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (mW)			
					34 (N)	550	XBDROY-00-0000-000000001	
				465	33 (M)	525	XBDROY-00-0000-000000M01	
Royal Blue	D36	450	D57		32 (L)	500	XBDROY-00-0000-000000L01	
				31 (K)	475	XBDROY-00-0000-000000K01		
				30 (J)	450	XBDROY-00-0000-0000000000000000000000000000		

	Domi	nant Wav	elength F	Range		rder Codes				
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Group Flux (Im)				
								M2	39.8	XBDBLU-00-0000-000000201
Blue	В3	465	B6	485	К3	35.2	XBDBLU-00-0000-000000Z01			
					K2	30.6	XBDBLU-00-0000-000000Y01			

	Domi	Dominant Wavelength Range Base Order Codes						
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	ıp Flux (lm)		
			520 G4		Q5	107	XBDGRN-00-0000-000000001	
Green	G2	520		64	C4	525	Q4 100	XBDGRN-00-0000-000000C01
Green	GZ	520		232	Q3	93.9	XBDGRN-00-0000-000000B01	
					Q2	87.4	XBDGRN-00-0000-000000A01	

	Dominant Wavelength Range					rder Codes						
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)						
				595	Р3	73.9	XBDAMB-00-0000-000000801					
Amber	A2	585	A3		505	FOF	505	505	505	P2	67.2	XBDAMB-00-0000-000000701
Amber	AZ.	565 A5	AS		N4	62	XBDAMB-00-0000-000000601					
				N3	56.8	XBDAMB-00-0000-000000501						



FLUX CHARACTERISTICS - COLOR (T₁ = 25 °C) - CONTINUED

	Domi	nant Wav	elength F	Range		rder Codes					
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)					
						O4 620	620	Q4	100	XBDRDO-00-0000-000000C01	
									Q3	93.9	XBDRDO-00-0000-000000B01
Red- Orange	03	610	04	04	04 62			Q2	87.4	XBDRDO-00-0000-000000A01	
J					P4	80.6	XBDRDO-00-0000-000000901				
					Р3	73.9	XBDRDO-00-0000-000000801				

	Domi	nant Wav	elength R	Range		rder Codes											
Color	Min. Max.		ax.	Min. Luminous Flux (Im) @ 350 mA		Order Code											
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)											
															P2	67.2	XBDRED-00-0000-000000701
Red	R2	620	R3	630	N4	62	XBDRED-00-0000-000000601										
					N3	56.8	XBDRED-00-0000-000000501										

Note: Cree maintains a tolerance of +/- 7% on flux and power measurements.



RELATIVE SPECTRAL POWER DISTRIBUTION







RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)





ELECTRICAL CHARACTERISTICS (T_j = 85 °C)



ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)





THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.





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RELATIVE FLUX VS. CURRENT (T₁ = 85 °C)



RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)





RELATIVE FLUX VS. CURRENT (T, = 25 °C) - CONTINUED



RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)









RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)

TYPICAL SPATIAL DISTRIBUTION







REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XB-D LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_ maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

In testing, Cree has found XLamp XB-D LEDs to have unlimited floor life in conditions \leq 30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtain from your Cree representative or obtained from the Product Ecology section of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh Declaration. Historical REACh banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

UL Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory Claim

WARNING: Do not look at exposed lamp in operation. Eye injury can result. See the LED Eye Safety application note at www.cree.com/xlamp_app_notes/led_eye_safety.



MECHANICAL DIMENSIONS

All measurements are \pm .13 mm unless otherwise indicated.



* Note: In December, 2012, Cree changed the thermal pad of the XB-D package to include the anode notch illustrated above. XB-D LEDs produced prior to implementation of this change may have a different visual appearance.





TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm

Tolerance unless specified: .XX \pm .25, .XXX \pm .125, X° \pm .5°





PACKAGING





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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